## IN THE CLAIMS:

The text of all pending claims are set forth below. Cancelled and withdrawn claims are indicated with claim number and status only. The claims as listed below show added text with underlining and deleted text with strikethrough. The status of each claim is indicated with one of (original), (currently amended), (previously amended), (cancelled), (withdrawn), (new), (previously added), (reinstated - formerly claim #), (previously reinstated), (re-presented - formerly dependent claim #) or, (previously re-presented).

Please AMEND claims 5 and 13-16 in accordance with the following:

- 1. (original) A resin composition comprising (A) 70 to 98% by weight of a polyphenylene ether resin or a mixture of a polyphenylene ether resin and a polystyrene-based resin, (B) 1 to 15% by weight of a hydrogenated product of an aromatic vinyl-conjugate diene block copolymer having an aromatic vinyl content of 50 to 80% by weight, and (C) 1 to 15% by weight of a hydrogenated product of an aromatic vinyl-isoprene block copolymer having an aromatic vinyl content of 15 to 45% by weight.
- 2. (original) The resin composition according to claim 1, wherein the polyphenylene ether resin has a weight-average molecular weight of from 8,000 to 80,000 and a molecular weight distribution of from 2.0 to 3.0.
- 3. (original) The resin composition according to claim 1, wherein component (A) is a mixture of a polyphenylene ether resin and a polystyrene-based resin.
- 4. (original) The resin composition according to claim 3, wherein the polystyrene-based resin is a resin comprising a conjugate diene polymer or a conjugate diene-aromatic vinyl block copolymer, having grafted thereto an aromatic vinyl chain, wherein the content of the conjugate diene is from 1 to 20% by weight, and the average dispersed particle size is from 0.5 to 3.0 micrometers.
- 5. (currently amended) The resin composition according to claim 4, wherein the conjugate diene has a 1,4-vinyl bond 1,4-bond amount of 90% or more.
- 6. (original) The resin composition according to claim 3, wherein the polystyrene-based resin has a weight-average molecular weight of from 170,000 to 400,000, and a molecular

weight distribution of from 1.5 to 3.5.

- 7. (original) The resin composition according to claim 1, wherein the aromatic vinyl-conjugate diene block copolymer (B) has a hydrogenation degree of 20% or more.
- 8. (original) The resin composition according to claim 1, wherein the aromatic vinyl-conjugate diene block copolymer (B) has a hydrogenation degree of 50% or more.
- 9. (original) The resin composition according to claim 1, wherein the aromatic vinylisoprene block copolymer (C) has a hydrogenation degree of 80% or more.
- 10. (original) The resin composition according to claim 1, wherein isoprene blocks in the aromatic vinyl-isoprene block copolymer (C) have a total amount of 1,2- and 3,4-vinyl bonds of 35% or more.
- 11. (original) The resin composition according to claim 1, wherein isoprene blocks in the aromatic vinyl-isoprene block copolymer (C) have a total amount of 1,2- and 3,4-vinyl bonds of 45% or more.
- 12. (original) The resin composition according to claim 1, wherein isoprene blocks in the aromatic vinyl-isoprene block copolymer (C) have a total amount of 1,2- and 3,4-vinyl bonds of 50% or more.
- 13. (currently amended) A resin composition comprising 100 parts by weight of the resin composition according to any one of claims claim 1 to 12 and (D) 0.1 to 5 parts by weight of an  $\alpha$ -olefinic copolymer.
- 14. (currently amended) A resin composition comprising 100 parts by weight of the resin composition according to any one of claims claim 1 to 13 and (E) 5 to 25 parts by weight of a polyolefin resin.
- 15. (currently amended) The resin composition according to any one of claims claim 1-to 14, further comprising a heat stabilizer or a coloring pigment.

- 16. (currently amended) A molded article comprising the resin composition according to any one of claims claim 1 to 15 and having a site with a thickness of 2 mm or less.
- 17. (original) The molded article according to claim 16, which is to be used for a site which comes into contact with an organic acid ester.